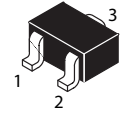
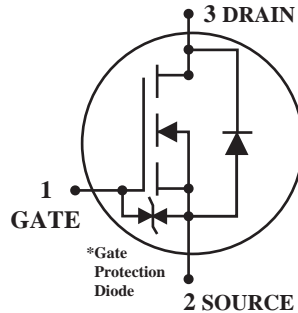


### N-Channel POWER MOSFET

**(Pb)** Lead(Pb)-Free



**SOT-323(SC-70)**

#### Description:

- \* Low on-resistance.
- \* Fast switching speed.
- \* Low voltage drive (2.5V) makes this device ideal for portable equipment.
- \* Easily designed drive circuits.
- \* Easy to parallel.

#### Features:

- \* Simple Drive Requirement
- \* Small Package Outline

### Maximum Ratings (T<sub>A</sub>=25°C Unless Otherwise Specified)

Rating	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current T <sub>A</sub> =25°C	I <sub>D</sub>	100	mA
Pulsed Drain Current (tp ≤ 10μs)	I <sub>DM</sub>	400	mA
Power Dissipation (T <sub>A</sub> =25°C)*	P <sub>D</sub>	200	mW
Operating Junction Temperature Range	T <sub>J</sub>	+150	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C

\* With each pin mounted on the recommended lands.

### Device Marking

2SK3018 = KN

## Electrical Characteristics (T<sub>A</sub>=25°C Unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>Static</b>					
Drain-Source Breakdown Voltage V <sub>GS</sub> =0V, I <sub>D</sub> =10μA	V <sub>(BR)DSS</sub>	30	-	-	V
Gate-Threshold Voltage V <sub>DS</sub> =3V, I <sub>D</sub> =100μA	V <sub>GS(th)</sub>	0.8	-	1.5	V
Gate-Source Leakage Current V <sub>GS</sub> =±20V	I <sub>GSS</sub>	-	-	±1.0	μA
Drain-Source Leakage Current V <sub>DS</sub> =30V, V <sub>GS</sub> =0	I <sub>DSS</sub>	-	-	1.0	μA
Static Drain-Source On-Resistance V <sub>GS</sub> =4V, I <sub>D</sub> =10mA V <sub>GS</sub> =2.5V, I <sub>D</sub> =1mA	R <sub>DS(on)</sub>	- -	5.0 7.0	8.0 13	Ω
Forward Transconductance V <sub>DS</sub> =3V, I <sub>D</sub> =10mA	g <sub>fs</sub>	20	-	-	mS

## Dynamic

Input Capacitance V <sub>DS</sub> =5V, V <sub>GS</sub> =0V, f=1.0MHz	C <sub>iss</sub>	-	13	-	pF
Output Capacitance V <sub>DS</sub> =5V, V <sub>GS</sub> =0V, f=1.0MHz	C <sub>oss</sub>	-	9	-	
Reverse Transfer Capacitance V <sub>DS</sub> =5V, V <sub>GS</sub> =0V, f=1.0MHz	C <sub>rss</sub>	-	4	-	

## Switching

Turn-On Time V <sub>GS</sub> =5V, I <sub>D</sub> =10mA, R <sub>L</sub> =500Ω, R <sub>G</sub> =10Ω	t <sub>d(on)</sub>	-	15	-	ns
Rise time V <sub>GS</sub> =5V, I <sub>D</sub> =10mA, R <sub>L</sub> =500Ω, R <sub>G</sub> =10Ω	t <sub>r</sub>	-	35	-	
Turn-Off delay Time V <sub>GS</sub> =5V, I <sub>D</sub> =10mA, R <sub>L</sub> =500Ω, R <sub>G</sub> =10Ω	t <sub>d(off)</sub>	-	80	-	
Fall time V <sub>GS</sub> =5V, I <sub>D</sub> =10mA, R <sub>L</sub> =500Ω, R <sub>G</sub> =10Ω	t <sub>f</sub>	-	80	-	

## TYPICAL ELECTRICAL CHARACTERISTICS

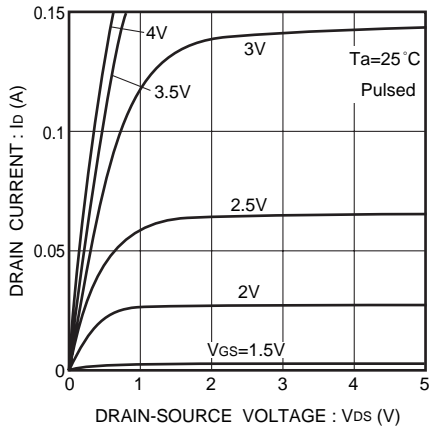


Fig.1 Typical output characteristics

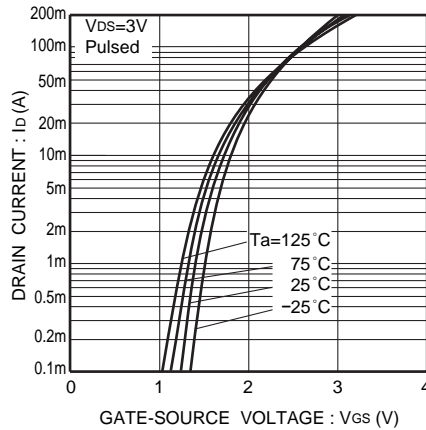


Fig.2 Typical transfer characteristics

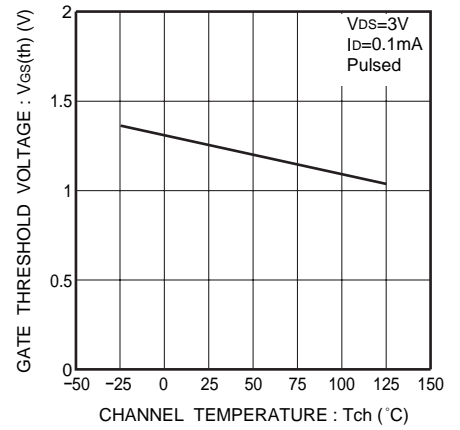


Fig.3 Gate threshold voltage vs. channel temperature

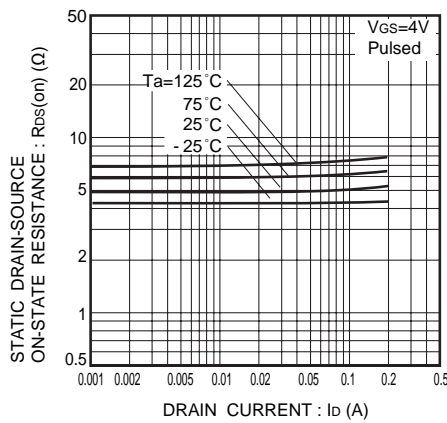


Fig.4 Static drain-source on-state resistance vs. drain current (I)

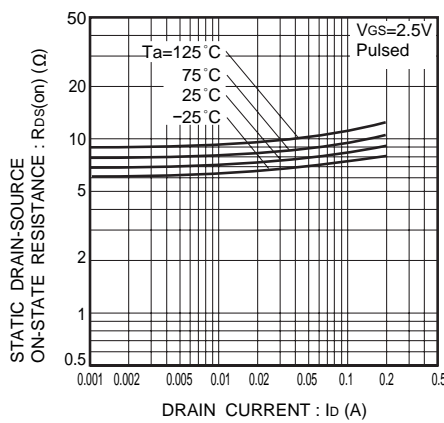


Fig.5 Static drain-source on-state resistance vs. drain current (II)

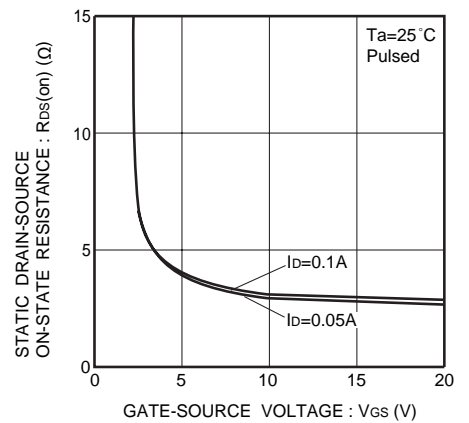


Fig.6 Static drain-source on-state resistance vs. gate-source voltage

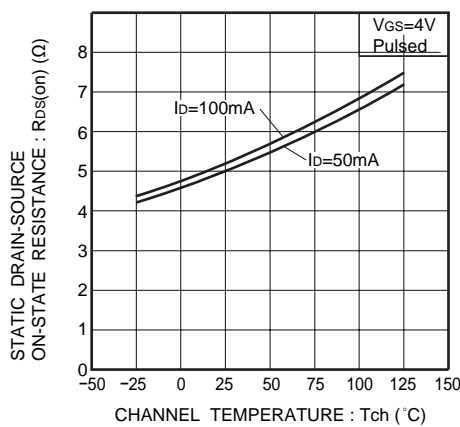


Fig.7 Static drain-source on-state resistance vs. channel temperature

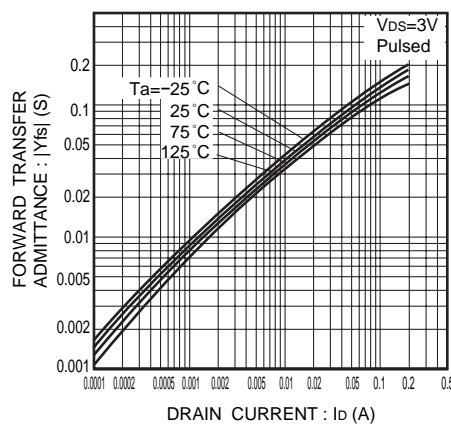


Fig.8 Forward transfer admittance vs. drain current

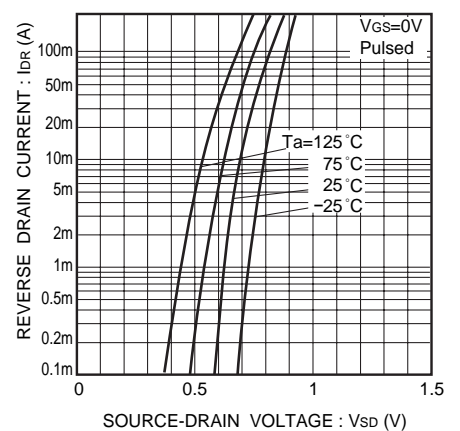


Fig.9 Reverse drain current vs. source-drain voltage (I)

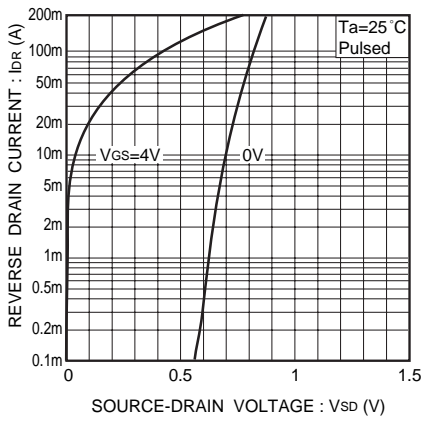


Fig.10 Reverse drain current vs. source-drain voltage ( II )

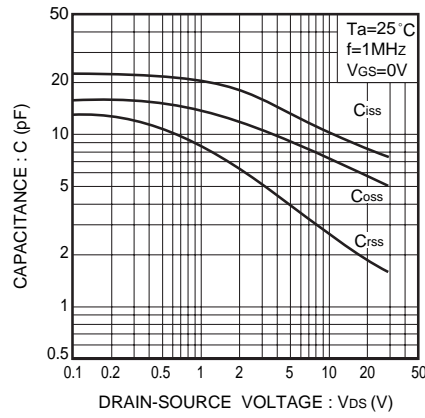


Fig.11 Typical capacitance vs. drain-source voltage

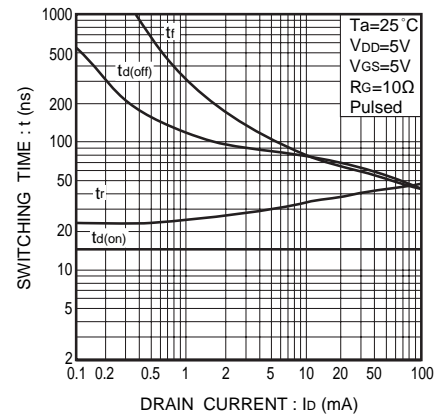


Fig.12 Switching characteristics (See Figures 13 and 14 for the measurement circuit and resultant waveforms)

### Switching characteristics measurement circuit

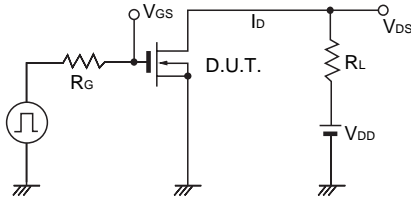


Fig.13 Switching time measurement circuit

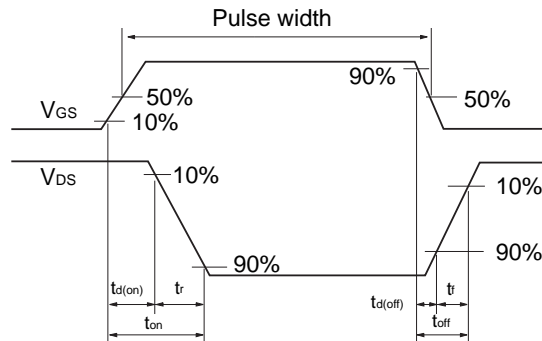
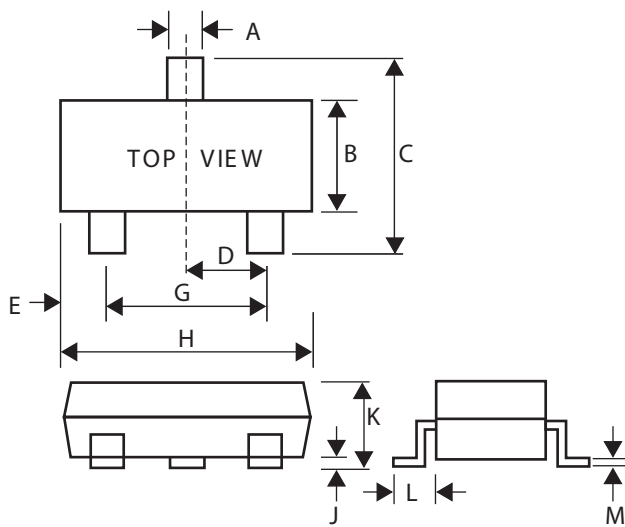


Fig.14 Switching time waveforms

## SOT-323 Outline Demensions

Unit:mm



SOT-323		
Dim	Min	Max
A	0.30	0.40
B	1.15	1.35
C	2.00	2.40
D	-	0.65
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.00	0.10
K	0.80	1.00
L	0.42	0.53
M	0.10	0.25